

International Symposium on Integrated Circuits and Systems

Singapore | September 3-4, 2021





CALL FOR PAPERS

IMPORTANT DATES

February 15, 2021 Submission Deadline

June 30, 2021

Notification of Acceptance

September 3-4, 2021

Conference Dates

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After the success of the past three symposiums, ISICAS 2021 will be a larger event and involves an additional journal, OJCAS. The symposium will not produce proceedings as all accepted papers will be published in Special Issues of TCAS-I, TCAS-II, TBioCAS, and OJCAS shortly after the results are presented at ISICAS 2021.

All submitted manuscripts must conform to the formatting and page count limit rules set by TCAS-I, TCAS-II, TBioCAS, and OJCAS.

The authors of accepted manuscripts, and those subject to (straightforward) minor revision at the time the ISICAS 2021 Technical program is drawn up, will be asked to present their work at the Symposium.

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